

A 3D CAD model of a mold assembly is shown. The mold is rendered in a light gray, semi-transparent style. Overlaid on the model are various colored regions representing simulation results: a large blue area at the top, a green area in the middle, and an orange area at the bottom. Thin yellow lines trace paths through the mold, likely representing the flow of molten material. The background is a soft, out-of-focus image of the same mold assembly.

Moldflow in the 4th Industrial Revolution

Rahul Patil and Hanno van Raalte

Product Managers | Moldflow Products



Disclaimer

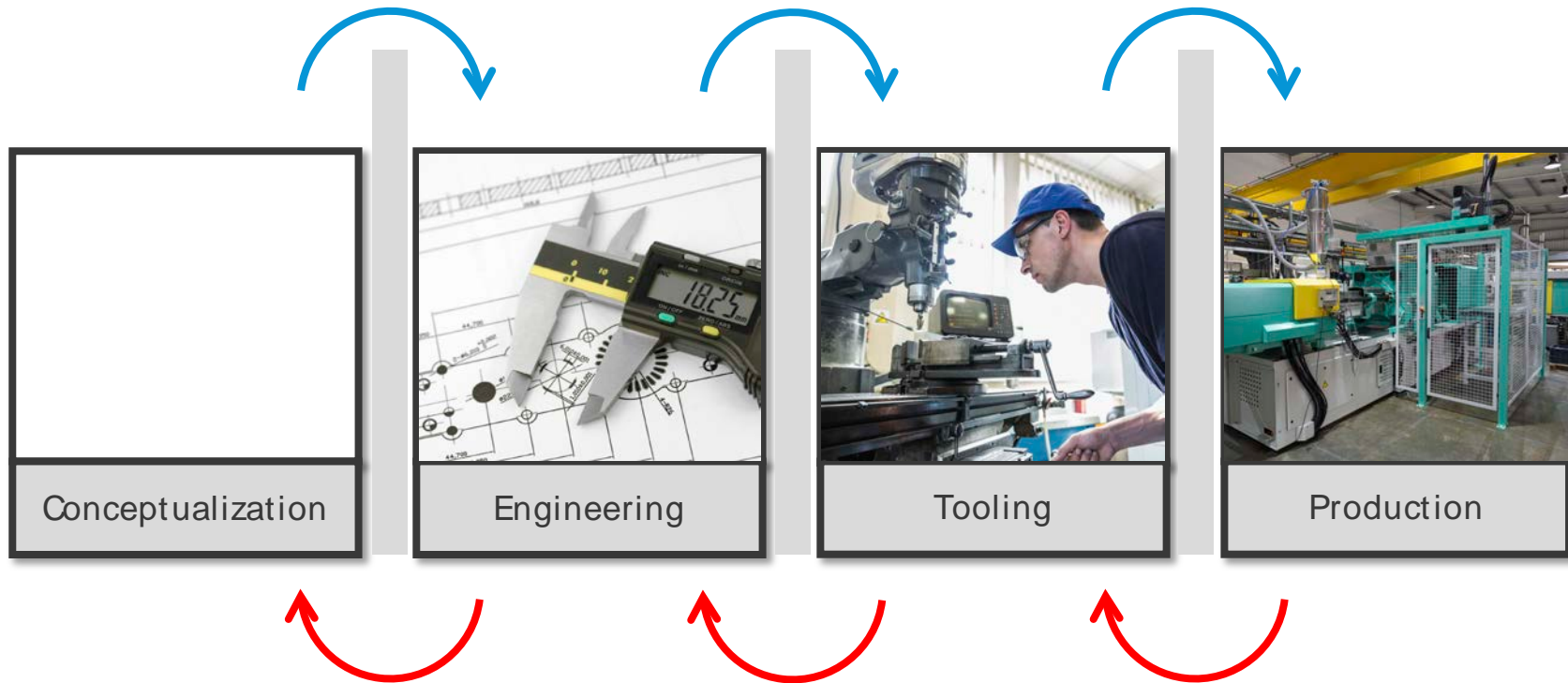
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The Company assumes no obligation to update these forward-looking statements to reflect events that occur or circumstances that exist or change after the date on which they were made.

A word cloud centered around the text "Industry 4.0". The words are arranged in a circular pattern around the central text. The words are in various sizes and colors, including dark red, orange, and brown. The words include: "Industry 4.0", "digital", "revolution", "cloud", "cyber", "future", "computing", "tech", "data", "machines", "internet", "automation", "sales", "smart", "resources", "trend", "automotive", "manufacturing", "intelligent", "engine", "project", "physical", "ideation", "business", "industrial", "strategy", "sector", "connectivity", "robot", "systems", "digitization", "logistics", "exchange", "industrie", "connected", "factory", "fourth", "render", "technology", "sensors", "strategic", "exchange", "industrie", "connected", "factory", "fourth", "render", "technology", "sensors", "strategic".

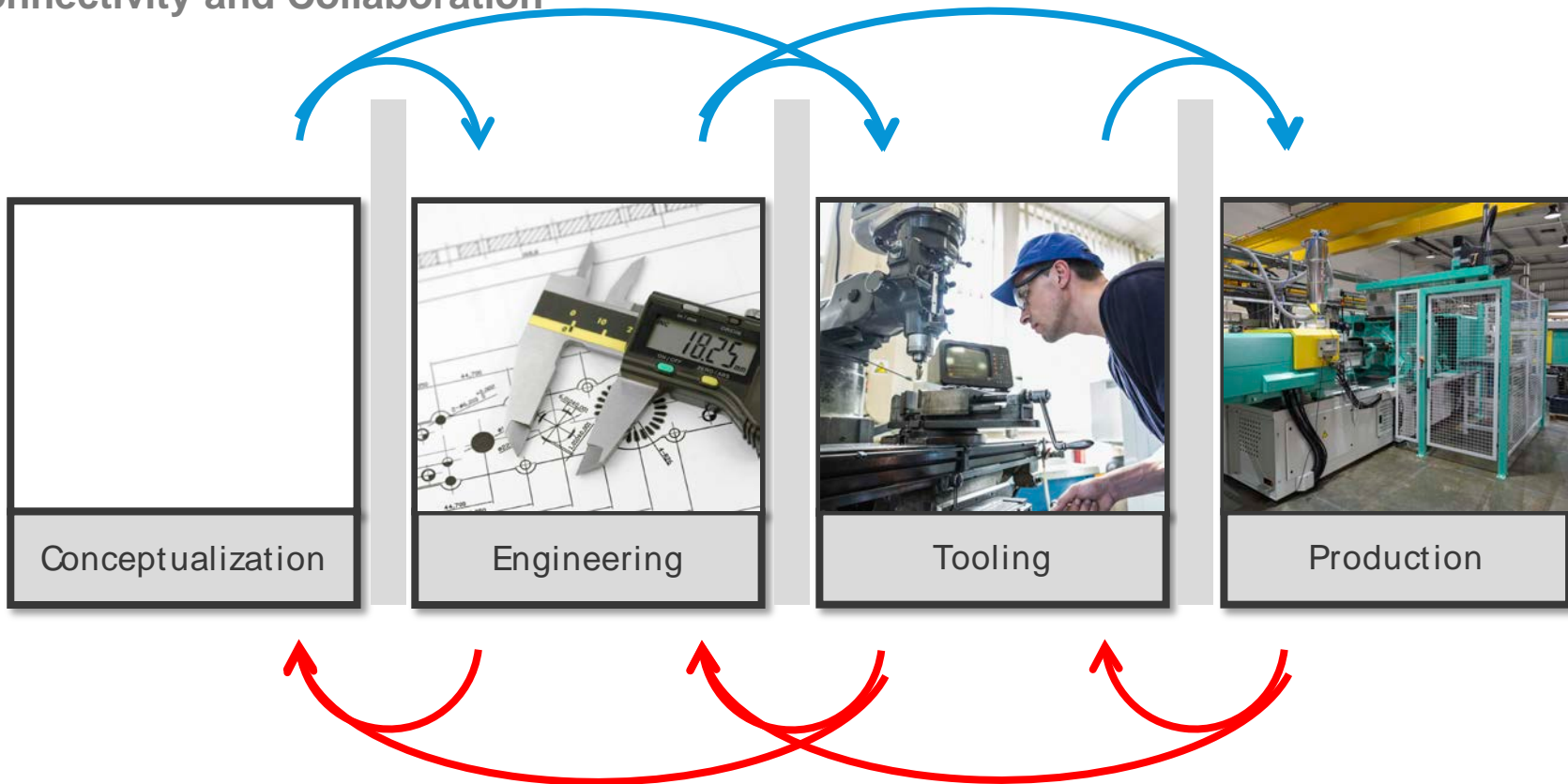
Industry Themes

Connectivity and Collaboration



Industry Themes

Connectivity and Collaboration



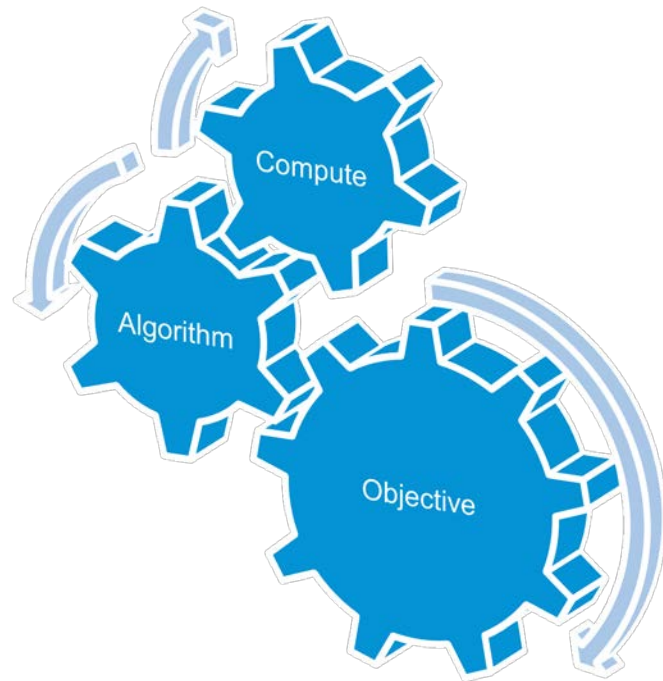
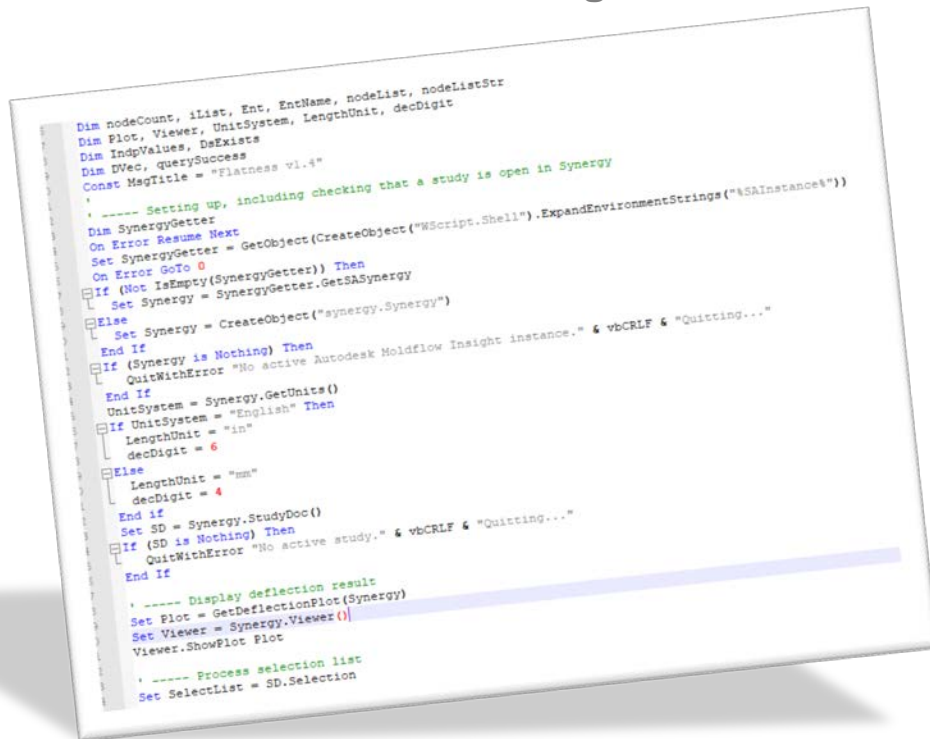
Industry Themes

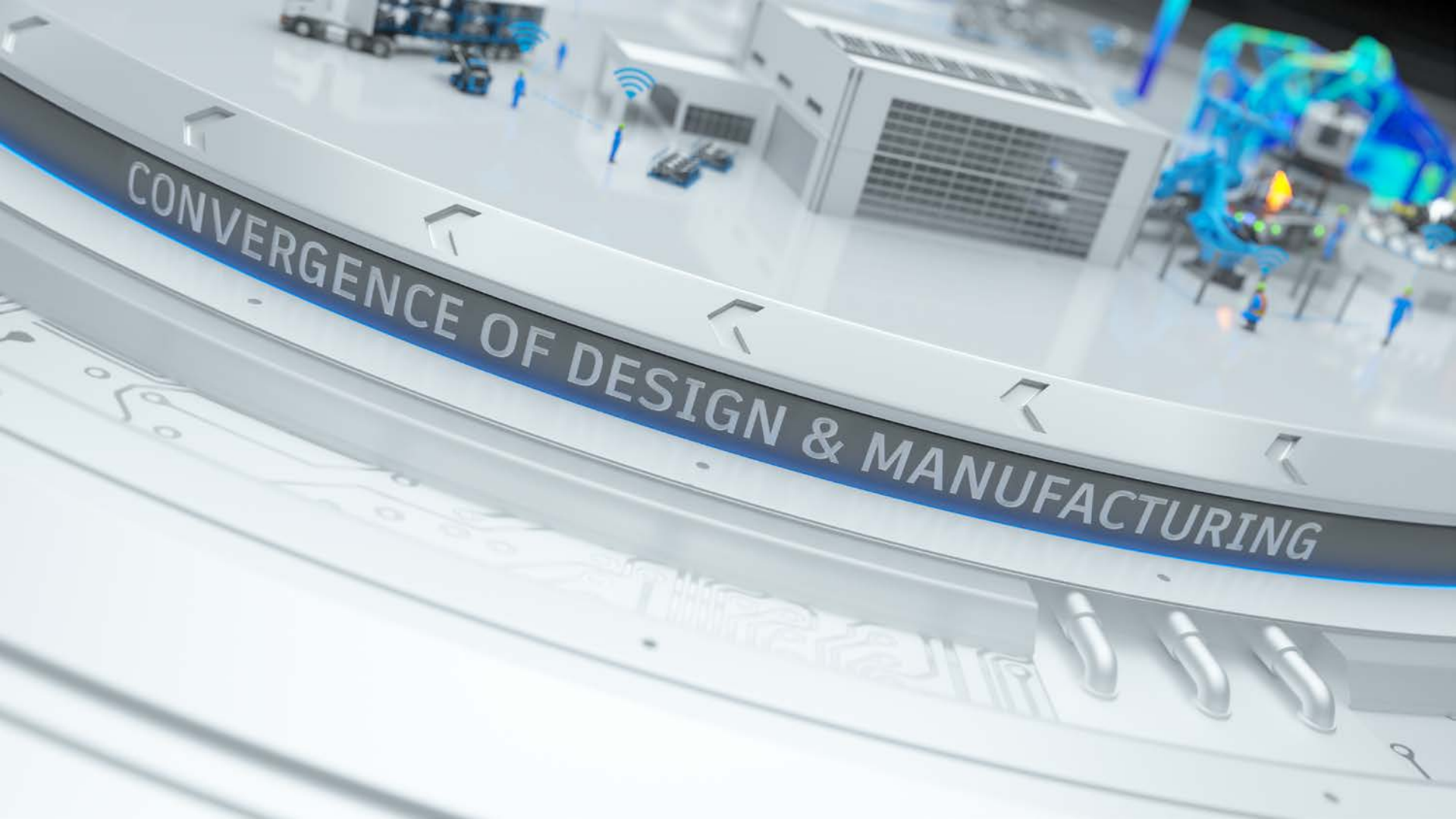
Data Centricity



Industry Themes

Automation and Machine Learning





CONVERGENCE OF DESIGN & MANUFACTURING

Moldflow



Market Leader



Performance & Accuracy



License Flexibility



>10k Materials



Integrations



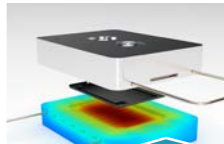
HPC & Cloud Solve



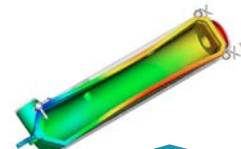
Meshing



Mold filling



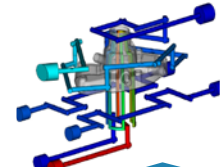
Mold Cooling



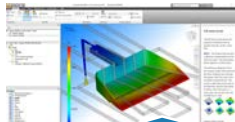
Warpage



Gas Assisted Inj. Molding



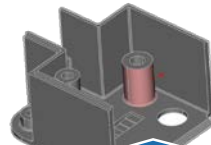
Conformal cooling



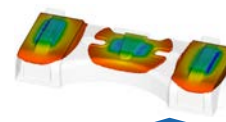
Collaboration



Accessibility



Geometry Manipulation



Compression Molding



As-Mfg. Analysis



Design of Experiments

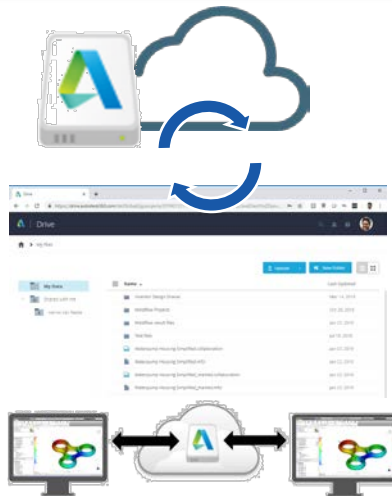
Moldflow

Value of Cloud

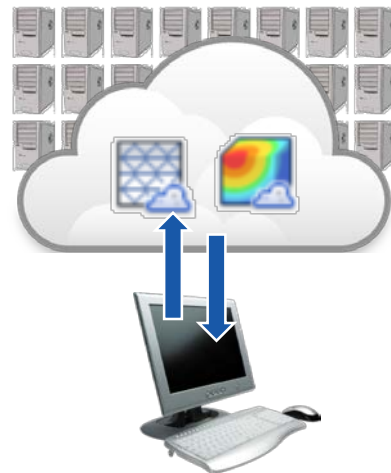
Sharing and Access



Collaboration

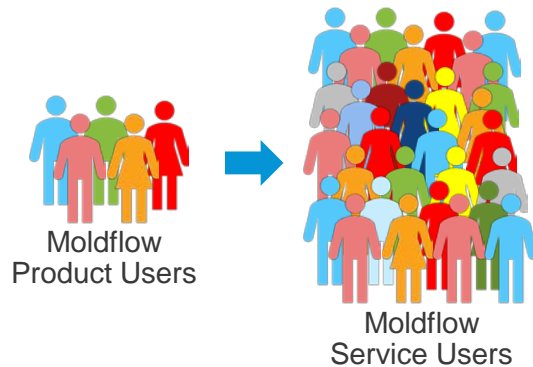


Compute

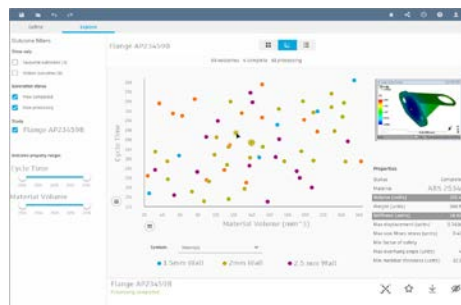


Moldflow

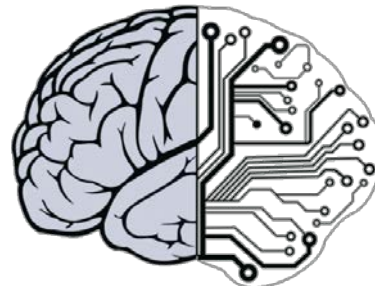
Unlocking Trapped Value



Adoption



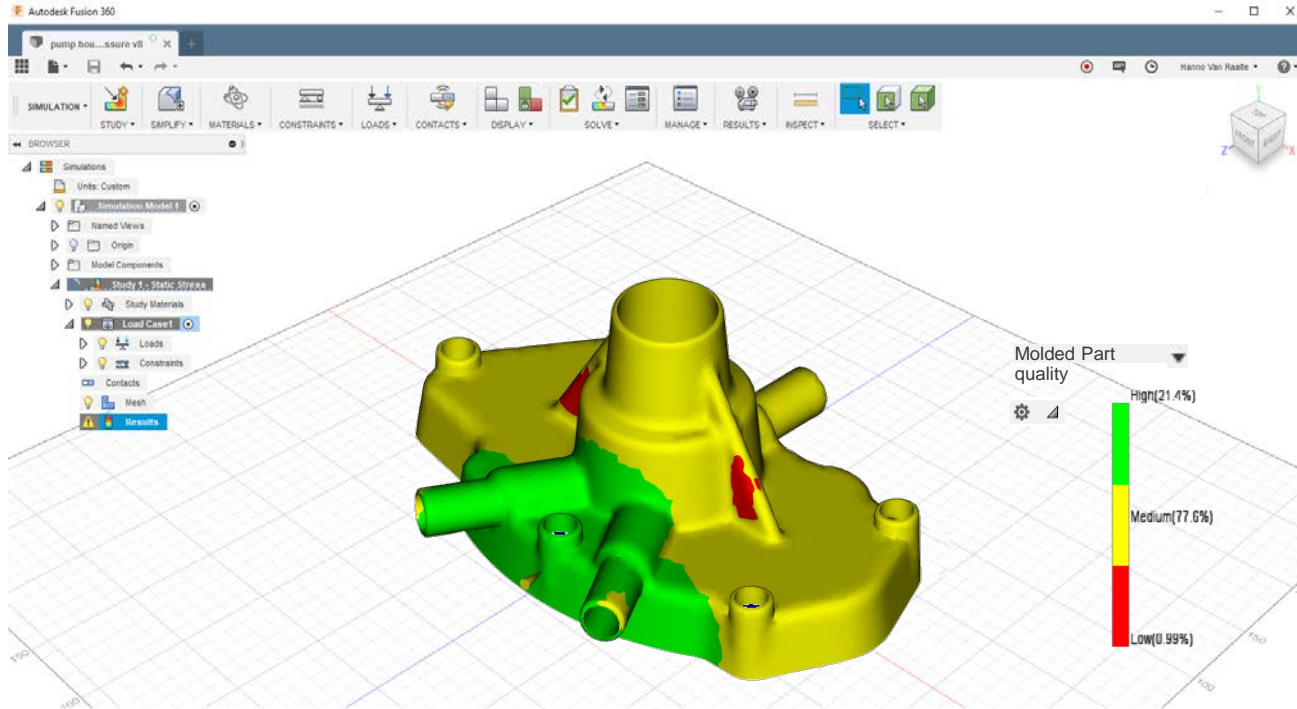
User Experience



Automation & ML

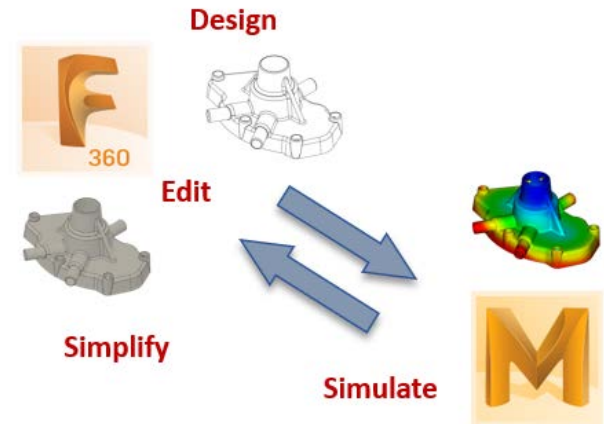
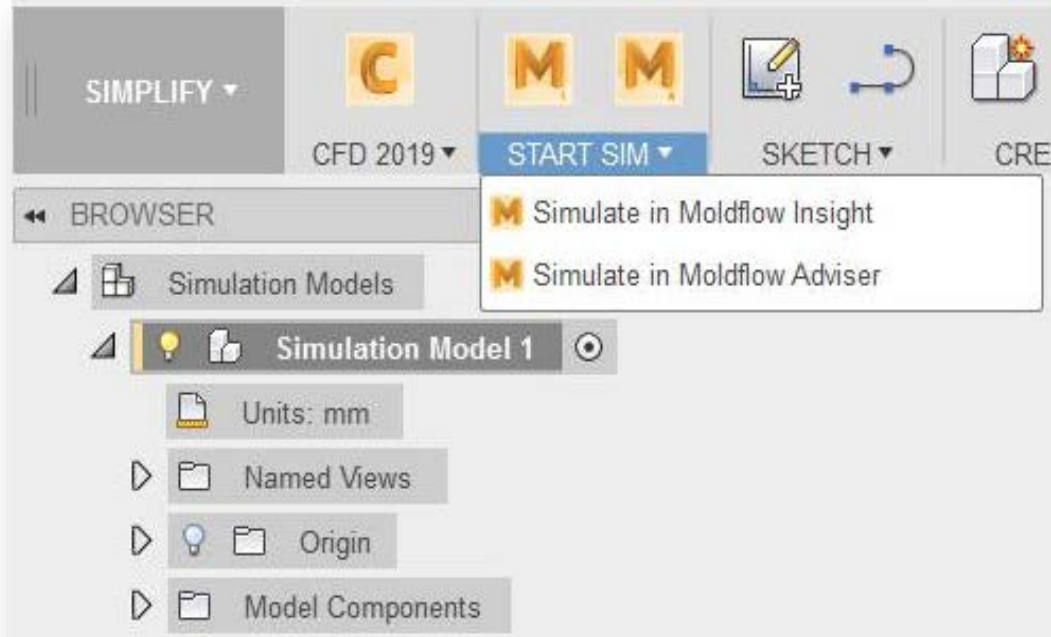
Moldflow tech in Fusion 360

Component Analysis



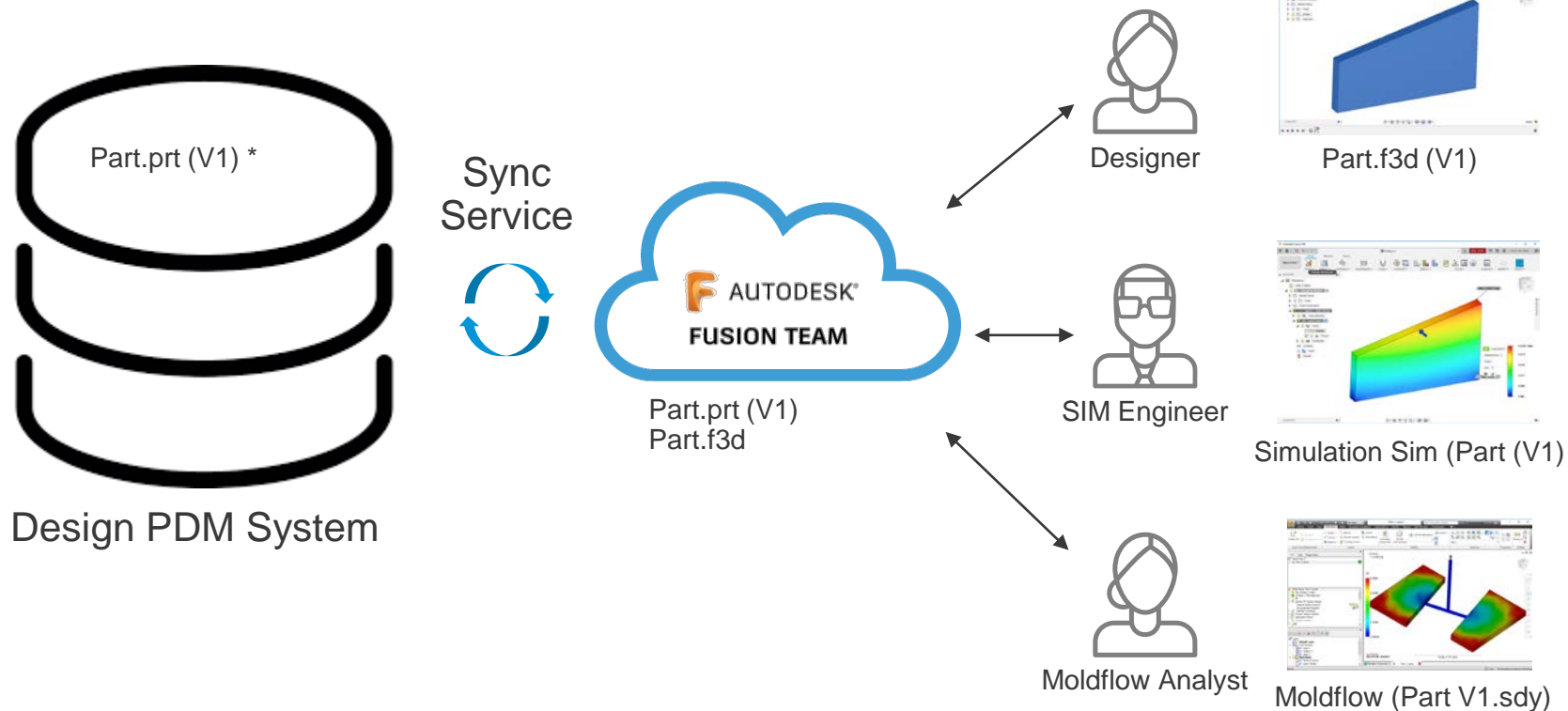
Moldflow

Fusion 360 Interoperability



Moldflow and Fusion 360

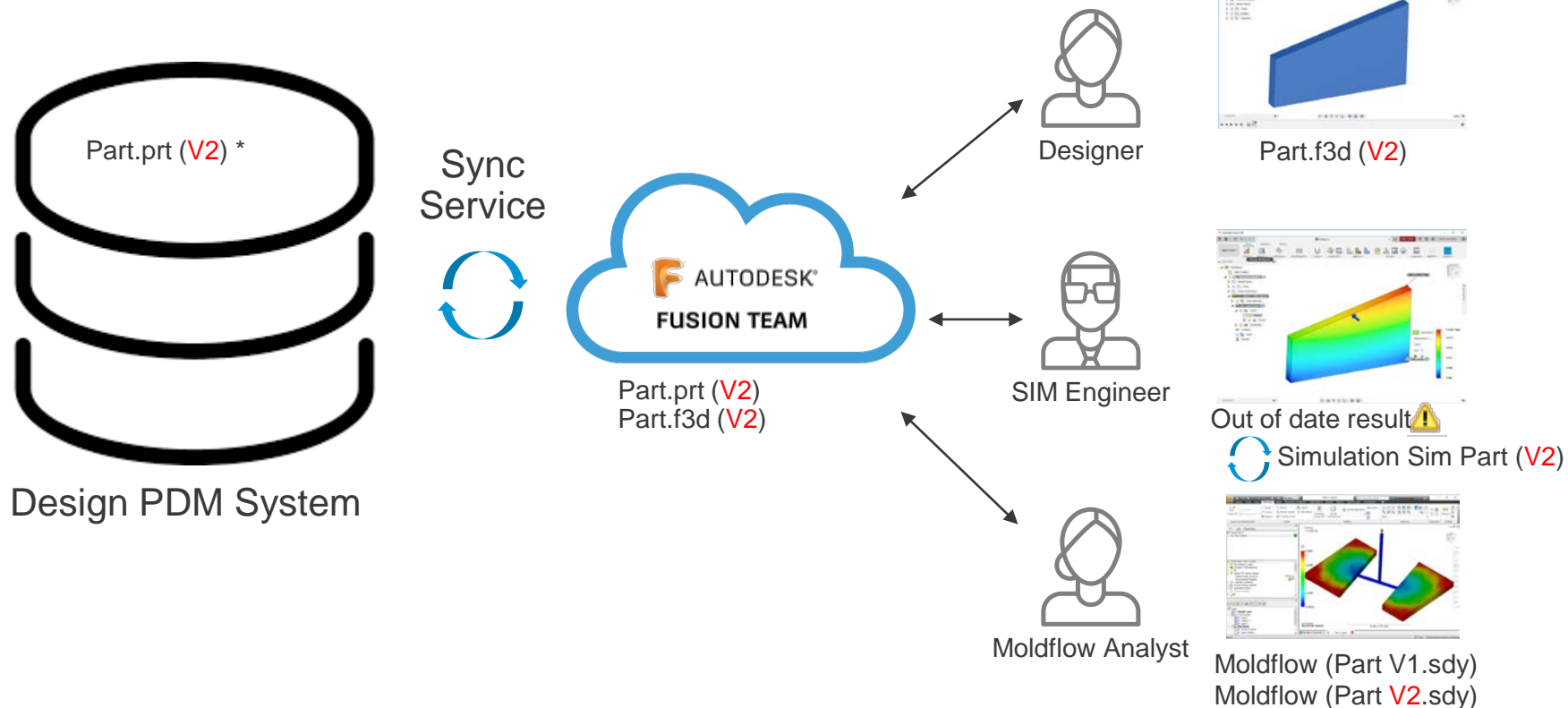
Fusion Team interaction with other PLM/PDM



Part.prt file used as an illustration of a non Autodesk CAD model
Part.f3d files is the translated file to Fusion model

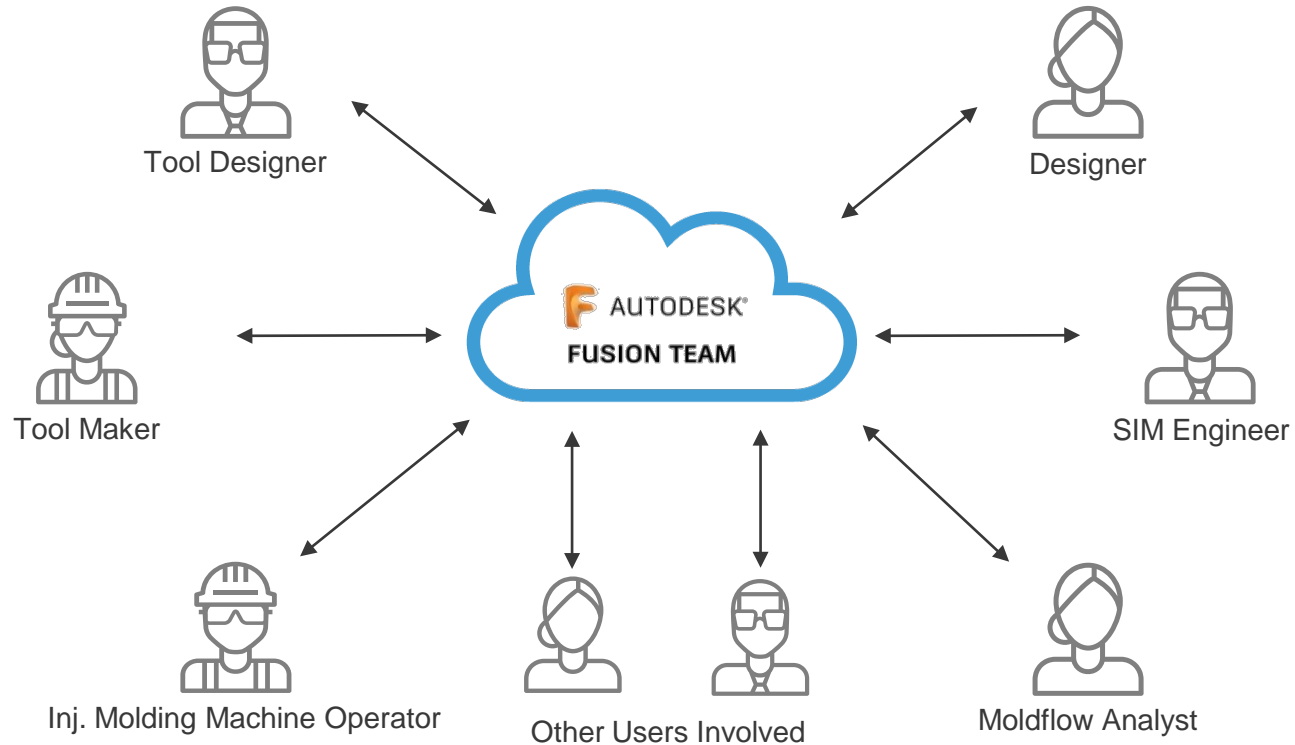
Moldflow and Fusion 360

Fusion Team interaction with other PLM/PDM



Fusion 360

Connecting different user types

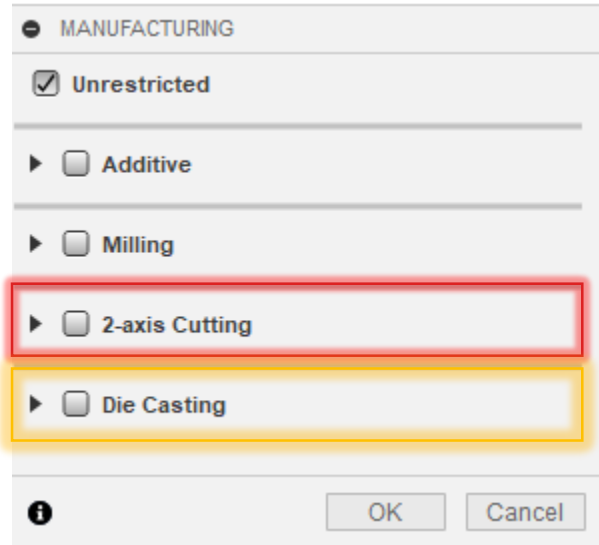
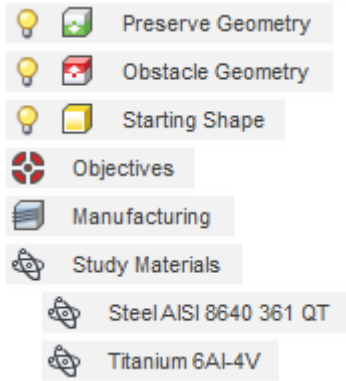


Fusion 360 – Generative Design



Generative Design Tech in Fusion 360 | Process

Select possible manufacturing method(s)



Available in preview as of May

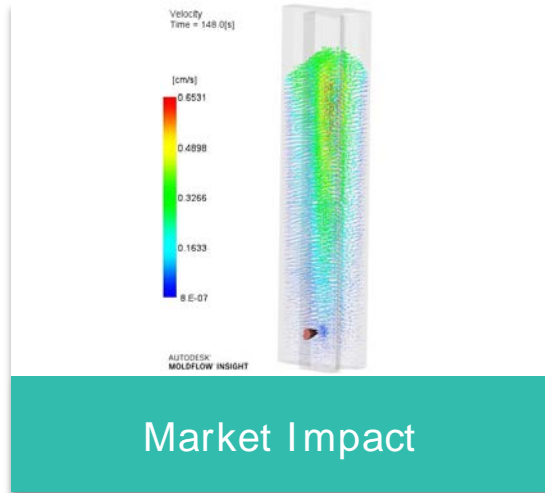
Available in Preview as of mid June

Moldflow

What's Next

Moldflow – What's Next

Tentative Content



- CAD Translator Updates
- PU Foaming
- Reactive Microcellular Injection Molding
- Support for FEA Solvers – Helius PFA



- Simulation Compute Manager
- Birefringence visualization

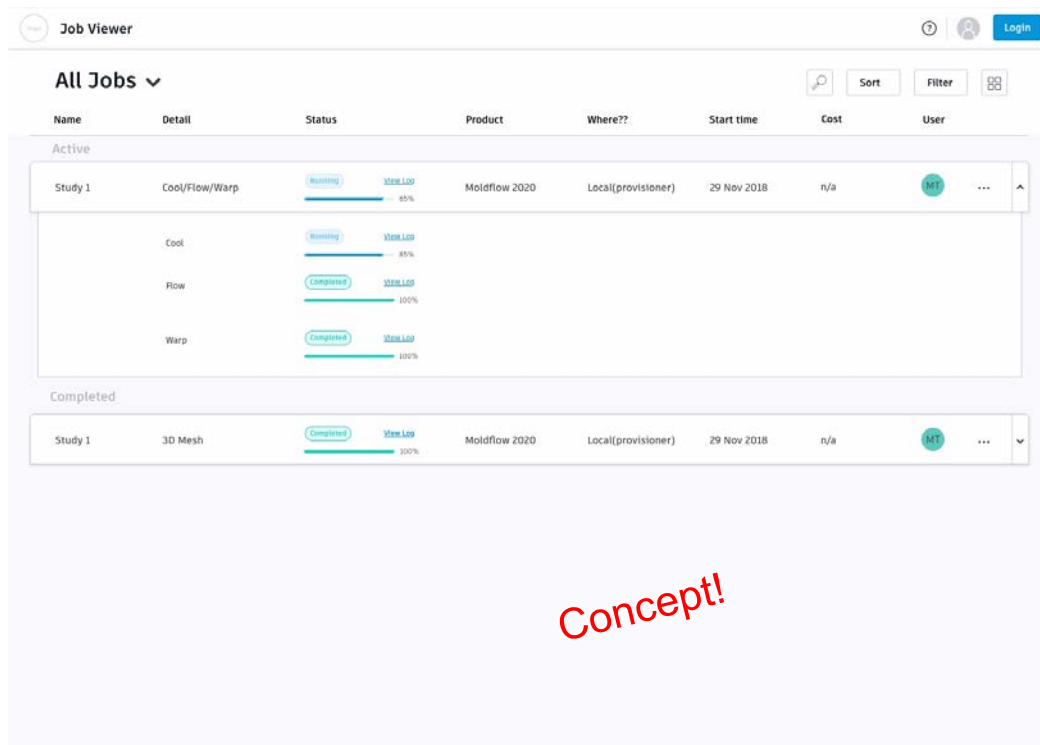


- Material Database Updates
- Solver API enhancements
 - Convected quantities
 - Fiber Orientation
- Retractable core-pin support
- Shrinkage accuracy improvement in 3D

Moldflow

Simulation Compute Manager (SCM)

- Simpler, faster and more robust
- Strong analysis queue focus.
- Browser based UI
- Follow analysis progression from PC, tablet or mobile device

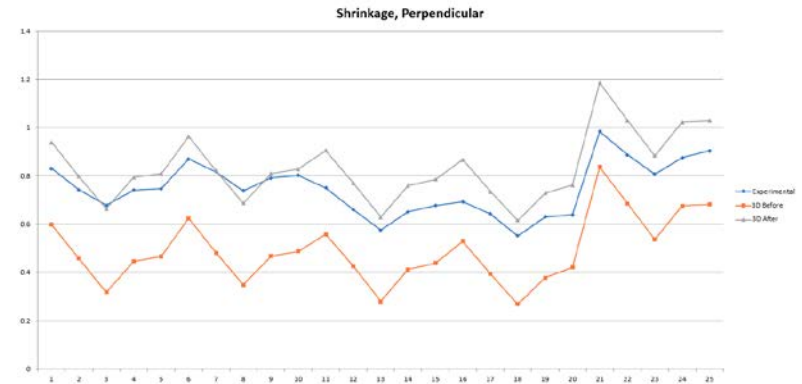
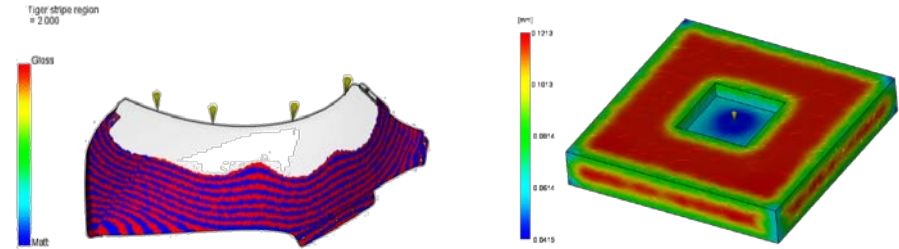


Concept!

Moldflow Research and Development

Ongoing Projects

- 3D Sink Marks on non-rib geometries
- PU Foaming (Chemical Foam Molding)
- Reactive Microcellular Foam Injection Molding
- Birefringence visualization
- Tiger Stripe predictions
- Improvement for 3D Weld-surface formation/movement
- Improved weld-strength model
- Updated FEA solver support for Helius
- Shrinkage accuracy improvement for 3D (crystallization effects)
- Solver API enhancements to support convected quantities and fiber orientation
- Improvements for mechanical property calculations for fiber/mineral filled materials
- Support for multiple insert contact in 3D Warp
- Viscoelastic stress relaxation
- Improved calculation of flow front temperature (3D)
- Improved handling of valve gate opening (3D)
- Use of Machine Learning to improve shrinkage correction
- Warp analysis including effects of assembly constraints and shrinkage allowance
- Use of shrinkage molding data for improved 3D warp/shrink accuracy (i.e. CRIMS for 3D)
- Improved pressure estimation used during automatic injection time, gate location, runner balance and molding window calculations.



Moldflow

External Partnerships

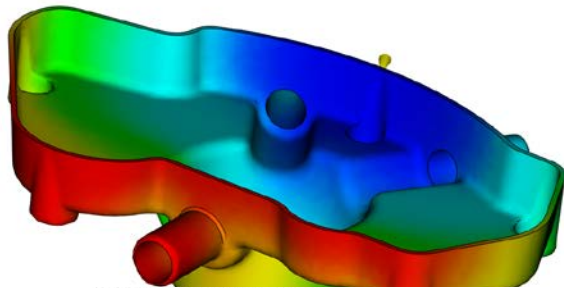
- Composite Injection OverMolding (TPRC)
- Fiber breakage in Barrel (U of Bradford)
- Improvement models of cell growth and nucleation during Microcellular Foam Inj Molding (U. of Toronto)
- Microchip encapsulation of large wafer/panels (iNEMI)
- Wall Slip (U of Tokyo)
- Fiber orientation and fiber concentration effects on viscosity/flow



Moldflow

Connecting to Injection Molding Machines

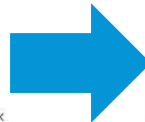
Fill time
= 2.057[s]



Process Settings Wizard - Fill-Pack Settings - Page 1 of 2

A screenshot of the 'Process Settings Wizard - Fill-Pack Settings' dialog box, Page 1 of 2. The dialog contains the following settings:

- Mold surface temperature: 180 °C
- Melt temperature: 270 °C
- Filling control: Injection time (dropdown) of 1.5 x [0]
- Velocity/pressure switch-over: Automatic (dropdown)
- Pack/holding control: 1/3 Filling pressure vs time (dropdown) with an 'Edit profile...' button
- Cooling time: Specified (dropdown) of 20 x [0]
- Buttons: 'Advanced options...' and 'Fiber Solver Parameters...'
- Checkboxes: ☒ 'Fiber orientation analysis if fiber material' and ☐ 'Birefringence analysis if material data includes optical properties'
- Navigation: '< Back', 'Next >', 'Cancel', and 'Help' buttons.



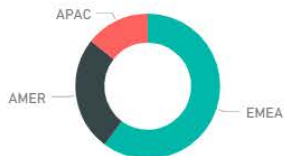
Moldflow – Education Seats

SIM EDU GRANTS

Product Line

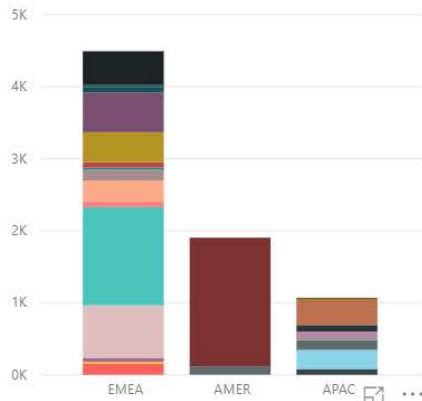
- ACMPAN
- MFIA
- NETFE
- NTFABLS

Seat Count by Geo



Seat Count by Geo and Deliver To Country

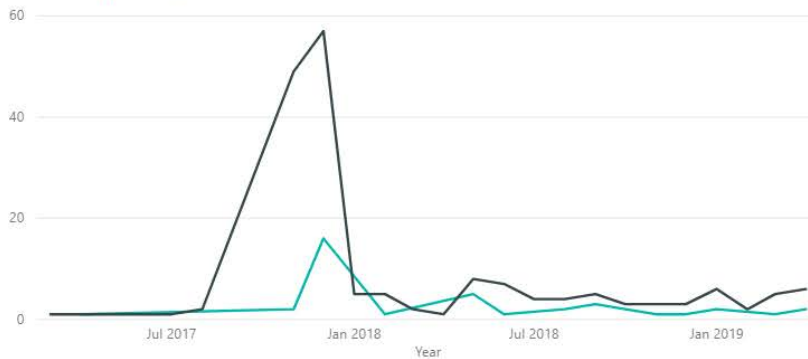
Deliver To C... Argentina Australia Austria



Number of EDU Grants created

Count of EDU Accounts by Year, Quarter, Month and Product Line

Product Line ACMPAN MFIA



EDU Accounts	Seat Count	Product Line	Deliver To Country	Geo
Inst Politécnico de Leiria	360	MFIA	Portugal	EMEA
Penn State University	300	ACMPAN	USA	AMER
Penn State University	300	MFIA	USA	AMER
Universitat Politècnica de Valencia	300	MFIA	Spain	EMEA
University Of Malta	150	MFIA	Malta	EMEA
Yuhan University	150	MFIA	South Korea	APAC
VTC Pro - Act T&D Ctr (Precision Eng)	132	MFIA	Hong Kong	APAC
University of Sheffield	130	ACMPAN	United Kingdom	EMEA
Lehigh University	125	MFIA	USA	AMER
Mondragon GOI Eskola Politeknikoa	125	ACMPAN	Spain	EMEA
Mondragon GOI Eskola Politeknikoa	125	MFIA	Spain	EMEA
Queens University Belfast	125	MFIA	United Kingdom	EMEA
Università di Padova	125	MFIA	Italy	EMEA
Universität Erlangen Nürnberg	125	MFIA	Germany	EMEA
BEIJING INSTITUTE OF PETROCHEMICAL TECHNOLOGY	100	MFIA	China	APAC
Clemson Univ	100	MFIA	USA	AMER
Lorenzetti Alessandra	100	MFIA	Italy	EMEA
Ostbayerische Technische Hochschule	100	MFIA	Germany	EMEA
Swansea University	100	MFIA	United Kingdom	EMEA
Total	7464			

Seat Count by Deliver To Country



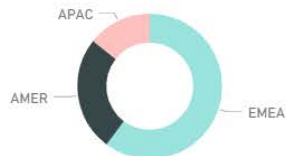
Moldflow – Education Seats

SIM EDU GRANTS

Product Line

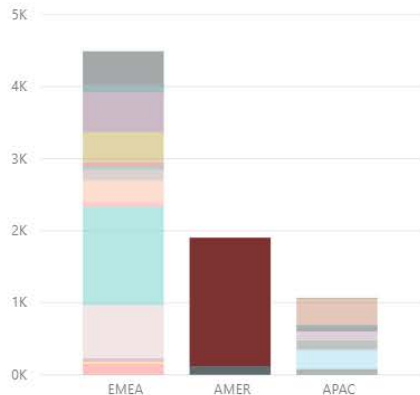
- ACMPAN
- MFIA
- NETFE
- NTFABLS

Seat Count by Geo



Seat Count by Geo and Deliver To Country

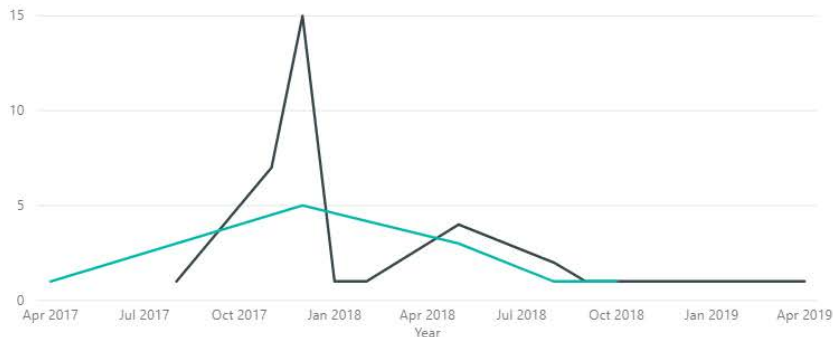
Deliver To C... Argentina Australia Austria



Number of EDU Grants created

Count of EDU Accounts by Year, Quarter, Month and Product Line

Product Line ACMPAN MFIA



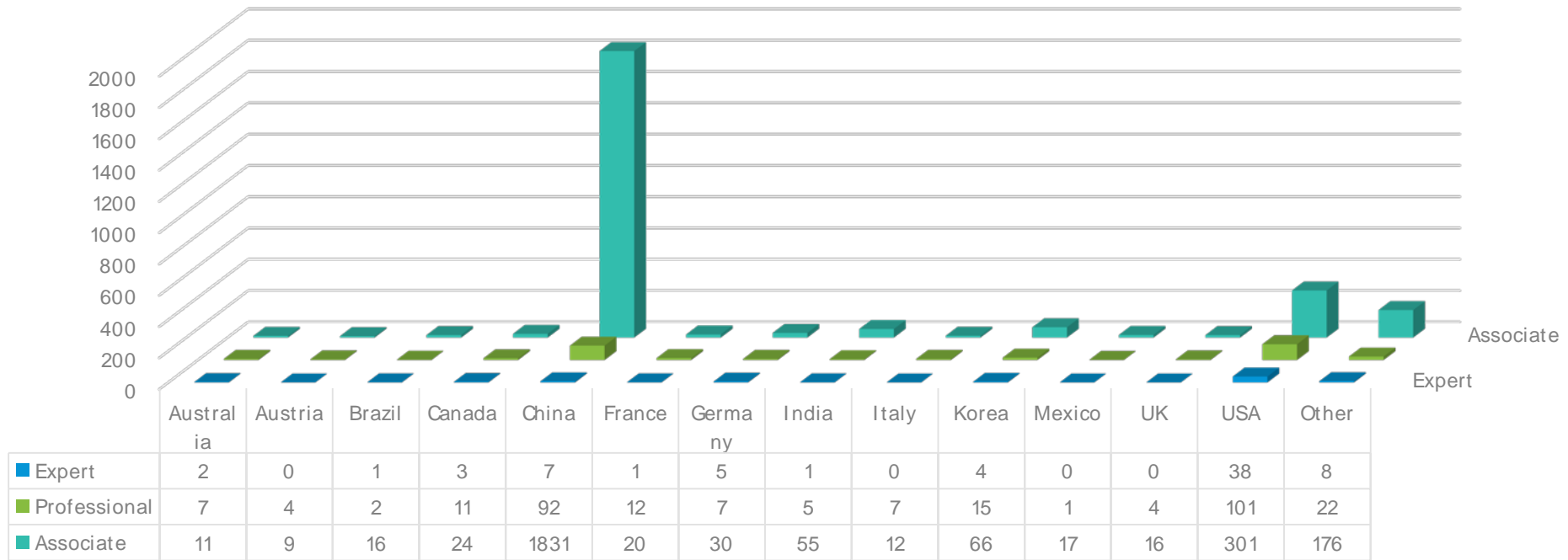
EDU Accounts	Seat Count	Product Line	Deliver To Country	Geo
Penn State University	300	ACMPAN	USA	AMER
Penn State University	300	MFIA	USA	AMER
Lehigh University	125	MFIA	USA	AMER
Clemson Univ	100	MFIA	USA	AMER
UMASS Lowell	100	ACMPAN	USA	AMER
UMASS Lowell	100	MFIA	USA	AMER
Univ of Wisconsin-Stout	80	MFIA	USA	AMER
Clemson Univ	50	ACMPAN	USA	AMER
Georgia Institute of Technology	50	MFIA	USA	AMER
IUPUI Indiana Univ	50	MFIA	USA	AMER
Penn State Erie, The Behrend	50	ACMPAN	USA	AMER
Schoolcraft College	45	MFIA	USA	AMER
Rochester Institute of Technology	40	ACMPAN	USA	AMER
Rochester Institute of Technology	40	MFIA	USA	AMER
Univ of Minnesota	35	MFIA	USA	AMER
Cegep de Thetford	34	MFIA	Canada	AMER
St Clair College	30	MFIA	Canada	AMER
Pennsylvania College of Technology	26	MFIA	USA	AMER
Baylor Univ	25	MFIA	USA	AMER
Total	1903			

Seat Count by Deliver To Country



Moldflow – Certification Program

Moldflow Certification Program





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Make anything[™]